

Electronic Acknowledgement Receipt

EFS ID:	2483039
Application Number:	10525996
International Application Number:	
Confirmation Number:	6221
Title of Invention:	Protective structure of semiconductor wafer, method for protecting semiconductor wafer, multilayer protective sheet used therein, and method for processing semiconductor wafer
First Named Inventor/Applicant Name:	Hideo Senoo
Correspondence Address:	Kent E Baldauf - 436 Seventh Avenue 700 Koppers Building Pittsburgh PA 15219-1818 US - -
Filer:	Kent E. Baldauf/Dianne Kimak
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Application Type:	U.S. National Stage under 35 USC 371

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File Listing:					
Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1	Amendment After Final	050618_AMEND.pdf	606834	no	6
			fd034c9126f13b097bca3263ed3ee8f9d1dbe231		
Warnings:					
Information:					
2	Extension of Time	050618_EXT.pdf	141730	no	2
			40d2d111fe53d94e16a11df1b8d2e5dec1bcec66		
Warnings:					
Information:					
3	Fee Worksheet (PTO-06)	050618_FEESHEET.pdf	108372	no	1
			ecb955a358abed7a2d396960678fab024e3c7873		
Warnings:					
Information:					
4	Request for Continued Examination (RCE)	050618_RCE.pdf	699645	no	3
			47b21bf5d0f911c2fbae9159052d4a1e3862e261		
Warnings:					
Information:					
5	Fee Worksheet (PTO-06)	fee-info.pdf	8398	no	2
			33ddc11caf8b17a3cb7b78d923724d87c1eb10b9		
Warnings:					
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Total Files Size (in bytes):			1564979		

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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

National Stage of an International Application under 35 U.S.C. 371

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

New International Application Filed with the USPTO as a Receiving Office

If a new international application is being filed and the international application includes the necessary components for an international filing date (see PCT Article 11 and MPEP 1810), a Notification of the International Application Number and of the International Filing Date (Form PCT/RO/105) will be issued in due course, subject to prescriptions concerning national security, and the date shown on this Acknowledgement Receipt will establish the international filing date of the application.